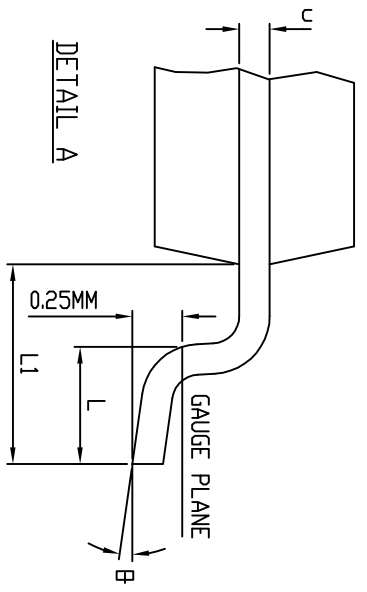
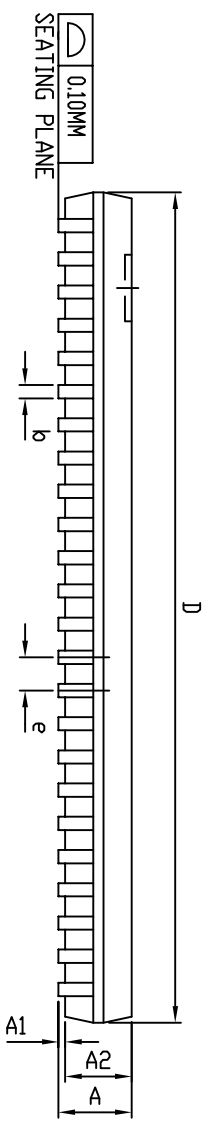


DETAIL A

NOTES

1. LEAD WIDTH AND LEAD THICKNESS EXCLUSIVE OF SOLDER PLATE
2. PACKAGE OUTLINE EXCLUSIVE OF MOLD FLASHES AND BURR DIMENSIONS
3. ALLOWABLE MOLD FLASH IS 5 MILS PER SIDE.
4. LEAD COPLANARITY IS 0.003 INCH MAX.



SYMBOL	DIMENSION IN MM		DIMENSION IN INCH	
	MIN.	NDM	MIN.	NDM
A		1.20		.047
A1	0.05	0.15	.002	.006
A2	0.80	1.00	.031	.039
D	12.40	12.50	.488	.492
E	8.00	8.10	.315	.319
E1	6.00	6.10	.236	.240
L	0.45	0.60	.018	.024
L1	1.00 REF.		.039 REF.	
b	0.18	0.20	.007	.008
e	0.50 BSC.		.020 BSC.	
c	0.09	0.20	.004	.008
θ	0	8	0	8
N	48			
REF	JEDEC MJ-153 VARIATION ED			



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TITLE:
POD for 48LD TSSOP(240 MIL),
0.50MM PITCH

DATE: 08/06/08	DOCUMENT NO. REV. A	SL/POD-00024
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Document History Page

Document Title: POD for 48LD TSSOP (240 MIL), 0.50MM PITCH

Document Number: SL/POD-00024 Rev. A

Rev.	ECR No.	Date	Orig. of Change	Description of Change
A	ECR-720	8/6/2008	RP	NEW RELEASE